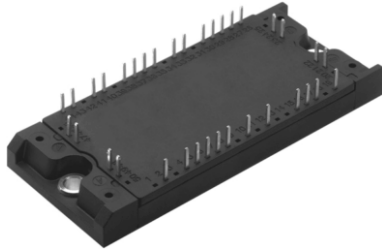


## IGBT Fourpack Module, 75 A


**ECONO2 4PACK**

### FEATURES

- Square RBSOA
- HEXFRED® low  $Q_{rr}$ , low switching energy
- Positive  $V_{CE(on)}$  temperature coefficient
- Copper baseplate
- Low stray inductance design
- Speed 8 kHz to 60 kHz
- Compliant to RoHS directive 2002/95/EC


**RoHS**  
COMPLIANT

### PRODUCT SUMMARY

|                               |        |
|-------------------------------|--------|
| $V_{CES}$                     | 1200 V |
| $I_C$ at $T_C = 67\text{ °C}$ | 75 A   |
| $V_{CE(on)}$ (typical)        | 3.4 V  |

### BENEFITS

- Benchmark efficiency for SMPS application in particular HF welding
- Rugged transient performance
- Low EMI, requires less snubbing
- Direct mounting to heatsink space saving
- PCB solderable terminals
- Low junction to case thermal resistance

### ABSOLUTE MAXIMUM RATINGS

| PARAMETER                                  | SYMBOL     | TEST CONDITIONS      | MAX.          | UNITS |
|--|------------|----------------------|---------------|-------|
| Collector to emitter voltage               | $V_{CES}$  |                      | 1200          | V     |
| Continuous collector current               | $I_C$      | $T_C = 25\text{ °C}$ | 100           | A     |
|  |            | $T_C = 80\text{ °C}$ | 67            |       |
| Pulsed collector current<br>See fig. C.T.5 | $I_{CM}$   |                      | 200           |       |
| Clamped inductive load current             | $I_{LM}$   |                      | 200           |       |
| Diode continuous forward current           | $I_F$      | $T_C = 25\text{ °C}$ | 60            |       |
|  |            | $T_C = 80\text{ °C}$ | 40            |       |
| Diode maximum forward current              | $I_{FM}$   |                      | 150           |       |
| Gate to emitter voltage                    | $V_{GE}$   |                      | $\pm 20$      |       |
| Maximum power dissipation (IGBT)           | $P_D$      | $T_C = 25\text{ °C}$ | 480           | W     |
|  |            | $T_C = 80\text{ °C}$ | 270           |       |
| Maximum operating junction temperature     | $T_J$      |                      | 150           | °C    |
| Storage temperature range                  | $T_{Stg}$  |                      | - 40 to + 125 |       |
| Isolation voltage                          | $V_{ISOL}$ |                      | AC 2500 (MIN) | V     |

| <b>ELECTRICAL SPECIFICATIONS</b> ( $T_J = 25\text{ }^\circ\text{C}$ unless otherwise specified) |                                |   |      |      |           |                      |
|---|--------------------------------|---|------|------|-----------|----------------------|
| PARAMETER   | SYMBOL                         | TEST CONDITIONS   | MIN. | TYP. | MAX.      | UNITS                |
| Collector to emitter breakdown voltage  | $V_{BR(CE)}$                   | $V_{GE} = 0\text{ V}$ , $I_C = 500\text{ }\mu\text{A}$  | 1200 | -    | -         | V                    |
| Collector to emitter voltage  | $V_{CE(ON)}$                   | $I_C = 75\text{ A}$ , $V_{GE} = 15\text{ V}$  | -    | 3.4  | 4.0       |                      |
|   |                                | $I_C = 100\text{ A}$ , $V_{GE} = 15\text{ V}$   | -    | 3.8  | 4.5       |                      |
|   |                                | $I_C = 75\text{ A}$ , $V_{GE} = 15\text{ V}$ , $T_J = 125\text{ }^\circ\text{C}$                      | -    | 4.0  | 4.5       |                      |
|   |                                | $I_C = 100\text{ A}$ , $V_{GE} = 15\text{ V}$ , $T_J = 125\text{ }^\circ\text{C}$                     | -    | 4.53 | 5.1       |                      |
| Gate threshold voltage  | $V_{GE(th)}$                   | $V_{CE} = V_{GE}$ , $I_C = 250\text{ }\mu\text{A}$  | 4.0  | 5.0  | 6.0       |                      |
| Threshold voltage temperature coefficient   | $\Delta V_{GE(th)}/\Delta T_J$ | $V_{CE} = V_{GE}$ , $I_C = 1\text{ mA}$ ( $25\text{ }^\circ\text{C}$ to $125\text{ }^\circ\text{C}$ ) | -    | - 11 | -         | mV/ $^\circ\text{C}$ |
| Zero gate voltage collector current   | $I_{CES}$                      | $V_{GE} = 0\text{ V}$ , $V_{CE} = 1200\text{ V}$  | -    | 7    | 250       | $\mu\text{A}$        |
|   |                                | $V_{GE} = 0\text{ V}$ , $V_{CE} = 1200\text{ V}$ , $T_J = 125\text{ }^\circ\text{C}$                  | -    | 580  | 2000      |                      |
| Diode forward voltage drop  | $V_{FM}$                       | $I_F = 75\text{ A}$   | -    | 3.7  | 4.9       | V                    |
|   |                                | $I_F = 100\text{ A}$  | -    | 4.1  | 5.5       |                      |
|   |                                | $I_F = 75\text{ A}$ , $T_J = 125\text{ }^\circ\text{C}$   | -    | 3.7  | 5.1       |                      |
|   |                                | $I_F = 100\text{ A}$ , $T_J = 125\text{ }^\circ\text{C}$  | -    | 4.2  | 5.7       |                      |
| Gate to emitter leakage current   | $I_{GES}$                      | $V_{GE} = \pm 20\text{ V}$  | -    | -    | $\pm 200$ | nA                   |

| <b>SWITCHING CHARACTERISTICS</b> ( $T = 25\text{ }^\circ\text{C}$ unless otherwise noted) |              |  |   |            |      |               |    |
|---|--------------|--|---|------------|------|---------------|----|
| PARAMETER   | SYMBOL       | TEST CONDITIONS  | MIN.  | TYP.       | MAX. | UNITS         |    |
| Total gate charge (turn-on)   | $Q_G$        | $I_C = 75\text{ A}$<br>$V_{CC} = 600\text{ V}$<br>$V_{GE} = 15\text{ V}$   | -   | 630        | -    | nC            |    |
| Gate to emitter charge (turn-on)  | $Q_{GE}$     |  | -   | 65         | -    |               |    |
| Gate to collector charge (turn-on)  | $Q_{GC}$     |  | -   | 250        | -    |               |    |
| Turn-on switching loss  | $E_{on}$     | $I_C = 75\text{ A}$ , $V_{CC} = 600\text{ V}$<br>$V_{GE} = 15\text{ V}$ , $R_g = 5\text{ }\Omega$ , $L = 500\text{ }\mu\text{H}$<br>$T_J = 25\text{ }^\circ\text{C}$ <sup>(1)</sup>  | -   | 1.74       | -    | mJ            |    |
| Turn-off switching loss   | $E_{off}$    |  | -   | 1.46       | -    |               |    |
| Total switching loss  | $E_{tot}$    |  | -   | 3.20       | -    |               |    |
| Turn-on switching loss  | $E_{on}$     |  | -   | 2.44       | -    |               |    |
| Turn-off switching loss   | $E_{off}$    | $I_C = 75\text{ A}$ , $V_{CC} = 600\text{ V}$<br>$V_{GE} = 15\text{ V}$ , $R_g = 5\text{ }\Omega$ , $L = 500\text{ }\mu\text{H}$<br>$T_J = 125\text{ }^\circ\text{C}$ <sup>(1)</sup> | -   | 2.35       | -    | mJ            |    |
| Total switching loss  | $E_{tot}$    |  | -   | 4.79       | -    |               |    |
| Turn-on delay time  | $t_{d(on)}$  |  | -   | 268        | -    |               |    |
| Rise time   | $t_r$        | $I_C = 75\text{ A}$ , $V_{CC} = 600\text{ V}$<br>$V_{GE} = 15\text{ V}$ , $R_g = 5\text{ }\Omega$ , $L = 500\text{ }\mu\text{H}$<br>$T_J = 125\text{ }^\circ\text{C}$                | -   | 43         | -    | ns            |    |
| Turn-off delay time   | $t_{d(off)}$ |  | -   | 308        | -    |               |    |
| Fall time   | $t_f$        |  | -   | 127        | -    |               |    |
| Reverse bias safe operating area  | RBSOA        |  | $T_J = 150\text{ }^\circ\text{C}$ , $I_C = 200\text{ A}$<br>$R_g = 10\text{ }\Omega$ , $V_{GE} = 15\text{ V}$ to $0\text{ V}$ | Fullsquare |      |               |    |
| Short circuit safe operating area   | SCSOA        | $T_J = 150\text{ }^\circ\text{C}$<br>$V_{CC} = 900\text{ V}$ , $V_P = 1200\text{ V}$<br>$R_g = 10\text{ }\Omega$ , $V_{GE} = 15\text{ V}$ to $0\text{ V}$                            | 10  | -          | -    | $\mu\text{s}$ |    |
| Diode peak reverse recovery current   | $I_{rr}$     | $V_{CC} = 200\text{ V}$<br>$I_F = 50\text{ A}$<br>$di/dt = 10\text{ A}/\mu\text{s}$  | $T_J = 25\text{ }^\circ\text{C}$  | -          | 13   | 18            | A  |
|   |              |  | $T_J = 125\text{ }^\circ\text{C}$   | -          | 19   | 23            |    |
| Diode reverse recovery time   | $t_{rr}$     |  | $T_J = 25\text{ }^\circ\text{C}$  | -          | 132  | 189           | ns |
|   |              |  | $T_J = 125\text{ }^\circ\text{C}$   | -          | 200  | 270           |    |
| Total reverse recovery charge   | $Q_{rr}$     |  | $T_J = 25\text{ }^\circ\text{C}$  | -          | 858  | 1700          | nC |
|   |              |  | $T_J = 125\text{ }^\circ\text{C}$   | -          | 1900 | 3105          |    |

**Note**

<sup>(1)</sup> Energy losses include “tail” and diode reverse recovery



| <b>THERMISTOR ELECTRICAL SPECIFICATIONS</b> (T = 25 °C unless otherwise specified) |                 |                              |       |       |      |       |
|--|-----------------|------------------------------|-------|-------|------|-------|
| PARAMETER  | SYMBOL          | TEST CONDITIONS              | MIN.  | TYP.  | MAX. | UNITS |
| Resistance   | R <sub>25</sub> |                              | 4538  | 5000  | 5495 | Ω     |
|  |                 | T <sub>J</sub> = 100 °C      | 468.6 | 493.3 | 518  |       |
| B value  | B               | T <sub>J</sub> = 25 °C/50 °C | 3307  | 3375  | 3443 | °K    |

| <b>THERMAL AND MECHANICAL SPECIFICATIONS</b> |                            |      |      |      |       |  |
|--|----------------------------|------|------|------|-------|--|
| PARAMETER                                    | SYMBOL                     | MIN. | TYP. | MAX. | UNITS |  |
| Junction to case IGBT                        | R <sub>thJC</sub> (IGBT)   | -    | -    | 0.26 | °C/W  |  |
| Junction to case DIODE                       | R <sub>thJC</sub> (DIODE)  | -    | -    | 0.56 |       |  |
| Case to sink, flat, greased surface          | R <sub>thCS</sub> (MODULE) | -    | 0.02 | -    |       |  |
| Mounting torque (M5)                         |                            | 2.7  | -    | 3.3  | Nm    |  |
| Weight                                       |                            | -    | 170  | -    | g     |  |

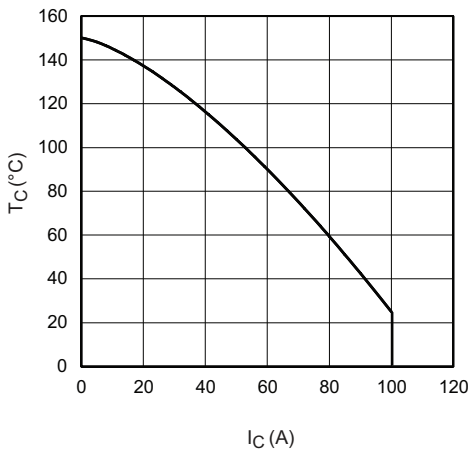


Fig. 1 - Maximum DC Collector Current vs. Case Temperature

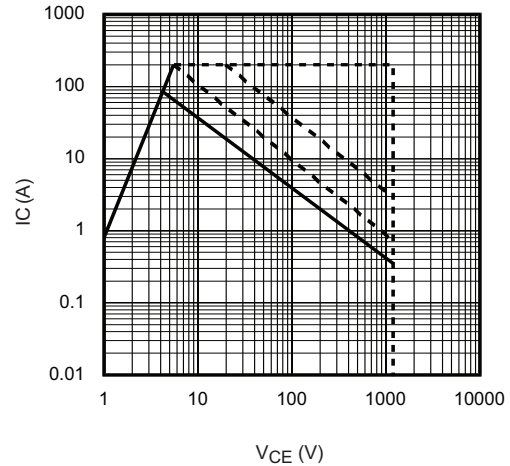


Fig. 3 - Forward SOA  
T<sub>C</sub> = 25 °C; T<sub>J</sub> ≤ 150 °C

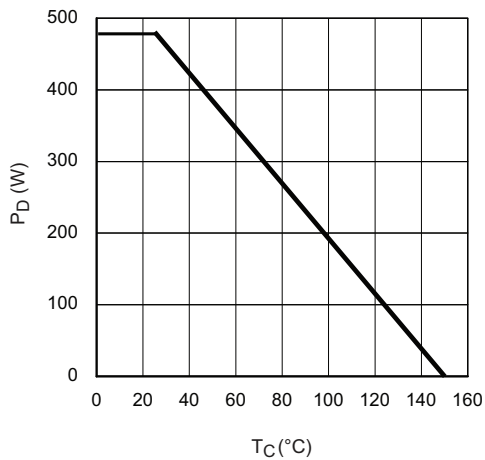


Fig. 2 - Power Dissipation vs. Case Temperature

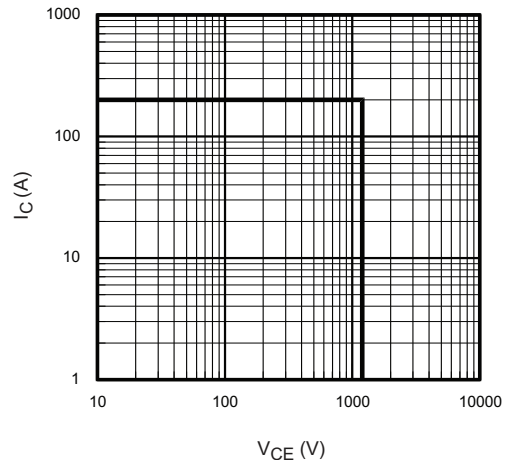


Fig. 4 - Reverse Bias SOA  
T<sub>J</sub> = 150 °C; V<sub>GE</sub> = 15 V

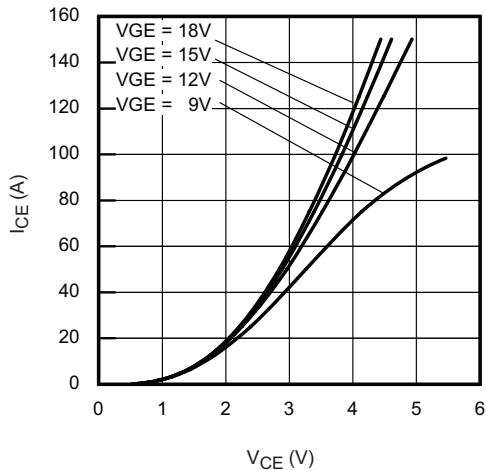


Fig. 5 - Typical IGBT Output Characteristics  
 $T_J = 25^\circ\text{C}$ ;  $t_p = 500 \mu\text{s}$

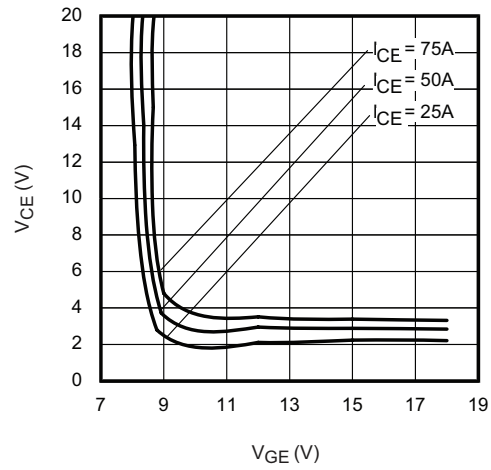


Fig. 8 - Typical  $V_{CE}$  vs.  $V_{GE}$   
 $T_J = 25^\circ\text{C}$

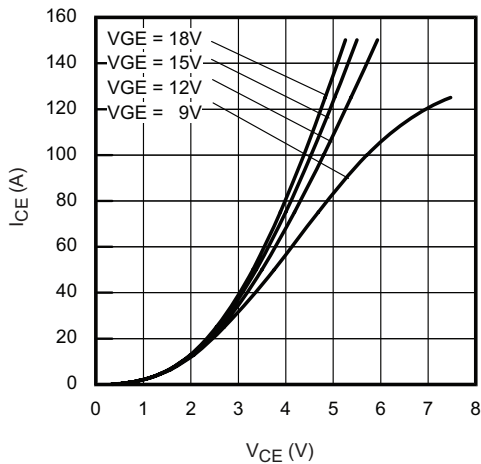


Fig. 6 - Typical IGBT Output Characteristics  
 $T_J = 125^\circ\text{C}$ ;  $t_p = 500 \mu\text{s}$

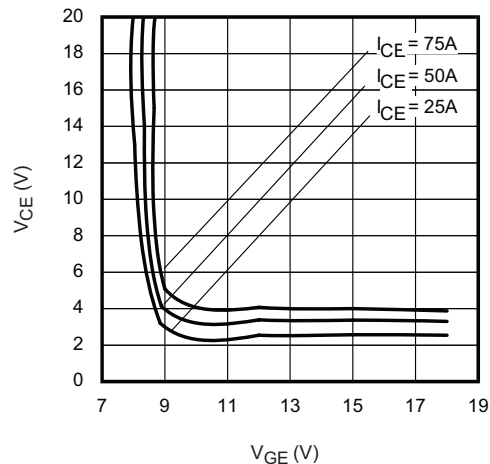


Fig. 9 - Typical  $V_{CE}$  vs.  $V_{GE}$   
 $T_J = 125^\circ\text{C}$

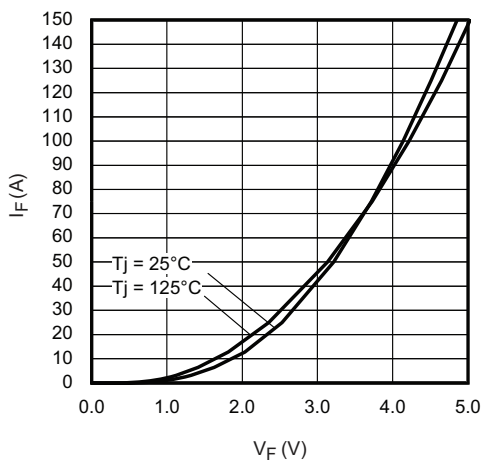


Fig. 7 - Typical Diode Forward Characteristics  
 $t_p = 500 \mu\text{s}$

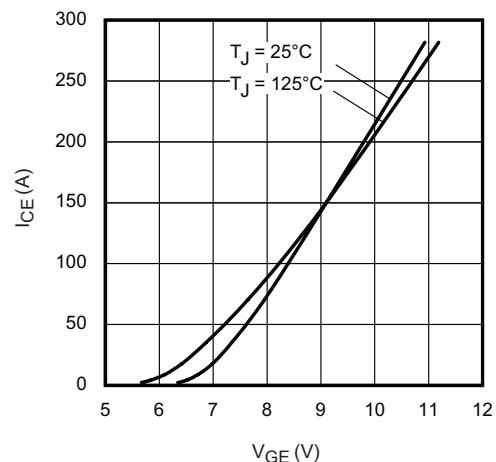


Fig. 10 - Typical Transfer Characteristics  
 $V_{CE} = 20 \text{ V}$ ;  $t_p = 500 \mu\text{s}$

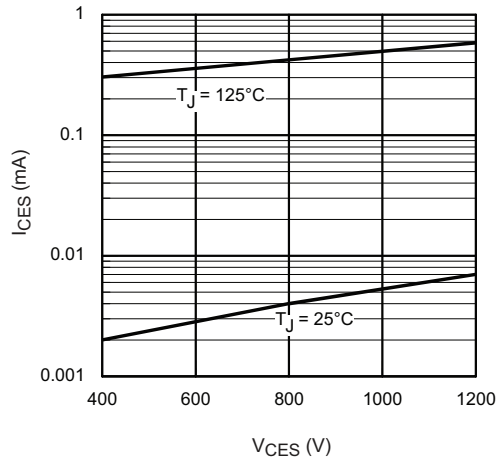


Fig. 11 - Typical Zero Gate Voltage Collector Current

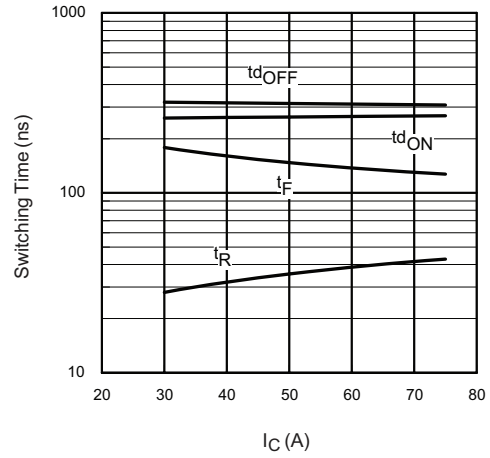
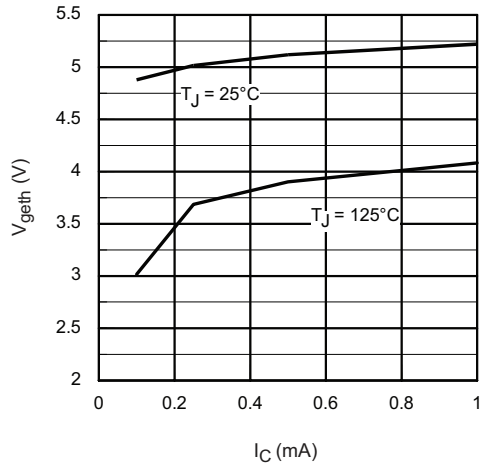
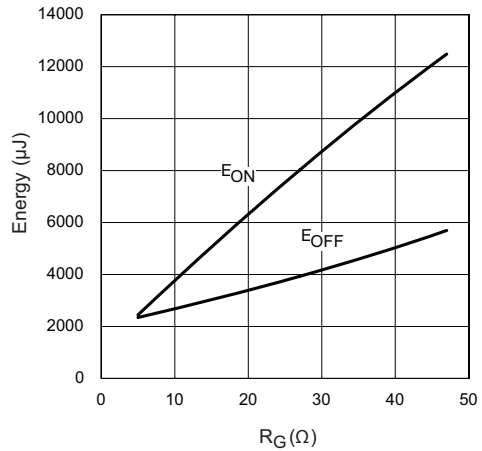
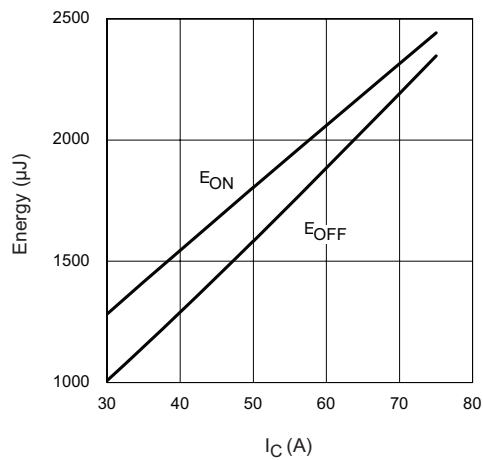
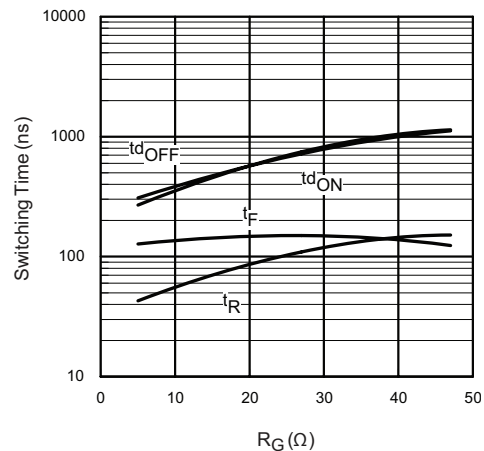

 Fig. 14 - Typical Switching Time vs.  $I_C$   
 $T_J = 125^\circ\text{C}$ ;  $L = 500\ \mu\text{H}$ ;  $V_{CC} = 600\ \text{V}$ ,  $R_g = 5\ \Omega$ ;  $V_{GE} = 15\ \text{V}$ 


Fig. 12 - Typical Threshold Voltage


 Fig. 15 - Typical Energy Loss vs.  $R_g$   
 $T_J = 125^\circ\text{C}$ ;  $L = 500\ \mu\text{H}$ ;  $V_{CC} = 600\ \text{V}$ ,  $I_C = 75\ \text{A}$ ;  $V_{GE} = 15\ \text{V}$ 

 Fig. 13 - Typical Energy Loss vs.  $I_C$   
 $T_J = 125^\circ\text{C}$ ;  $L = 500\ \mu\text{H}$ ;  $V_{CC} = 600\ \text{V}$ ,  $R_g = 5\ \Omega$ ;  $V_{GE} = 15\ \text{V}$ 

 Fig. 16 - Typical Switching Time vs.  $R_g$   
 $T_J = 125^\circ\text{C}$ ;  $L = 500\ \mu\text{H}$ ;  $V_{CC} = 600\ \text{V}$ ,  $I_C = 75\ \text{A}$ ;  $V_{GE} = 15\ \text{V}$

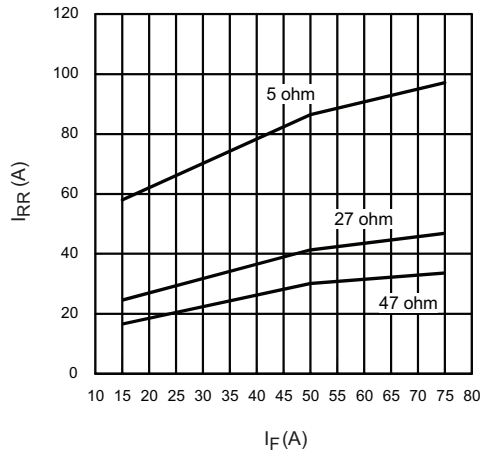


Fig. 17 - Typical Diode  $I_{RR}$  vs.  $I_F$   
 $T_J = 125^\circ\text{C}$

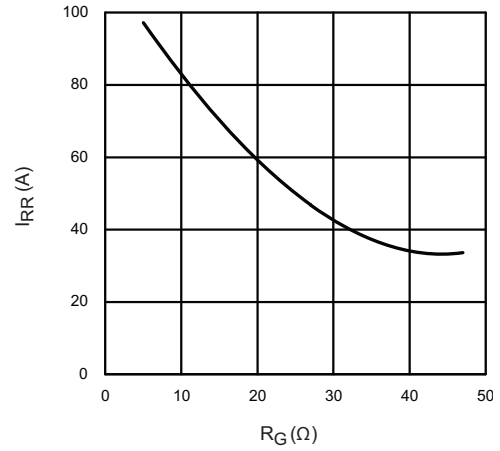


Fig. 19 - Typical Diode  $I_{RR}$  vs.  $R_G$   
 $T_J = 125^\circ\text{C}; I_F = 75\text{ A}$

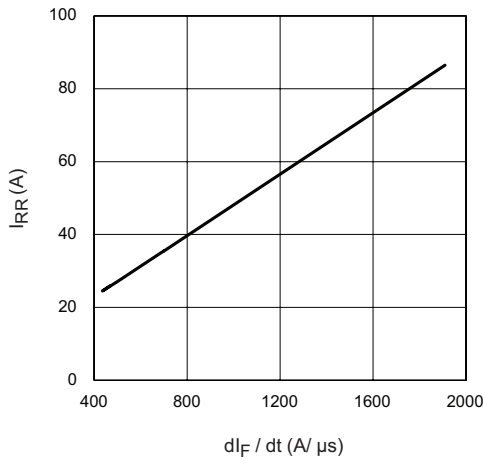


Fig. 18 - Typical Diode  $I_{RR}$  vs.  $dI_F/dt$   
 $V_{CC} = 600\text{ V}; I_F = 75\text{ A}$

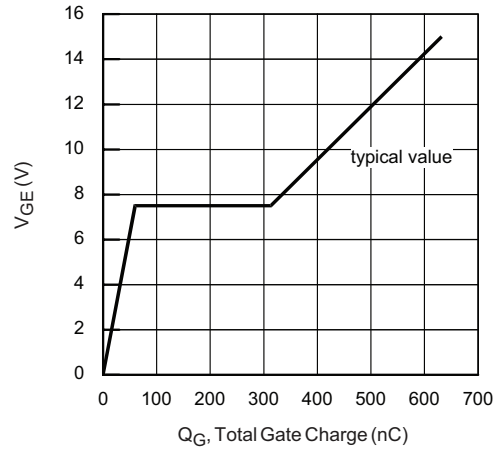


Fig. 20 - Typical Gate Charge vs.  $V_{GE}$   
 $I_{CE} = 5.0\text{ A}; L = 600\text{ }\mu\text{H}$

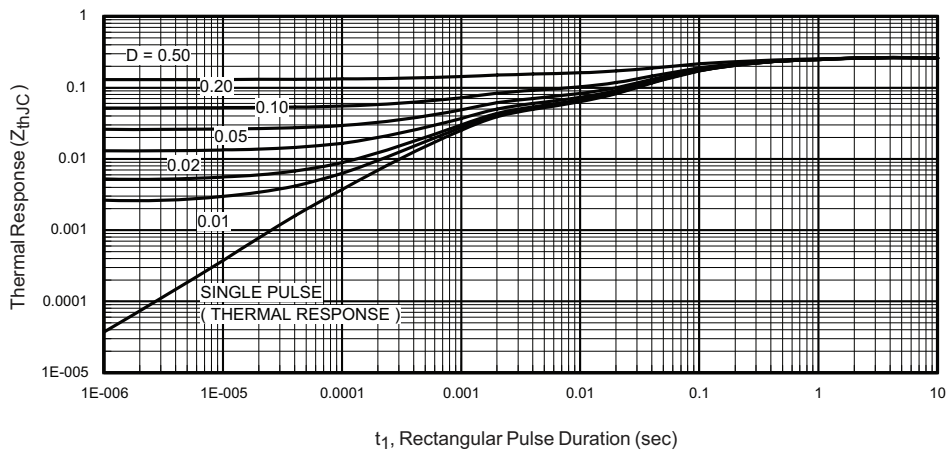


Fig. 21 - Maximum Transient Thermal Impedance, Junction to Case (IGBT)

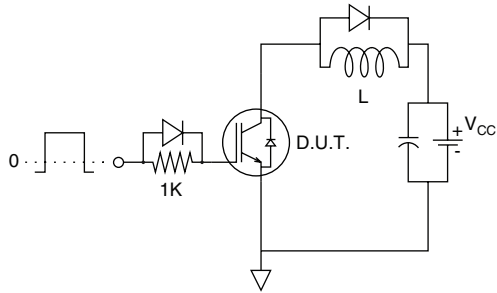


Fig. C.T.1 - Gate Charge Circuit (Turn-Off)

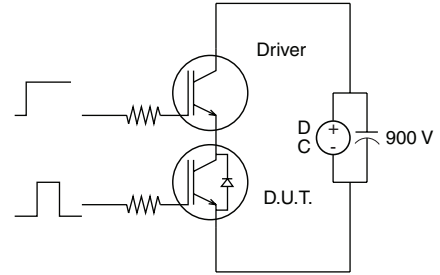


Fig. C.T.3 - S.C. SOA Circuit

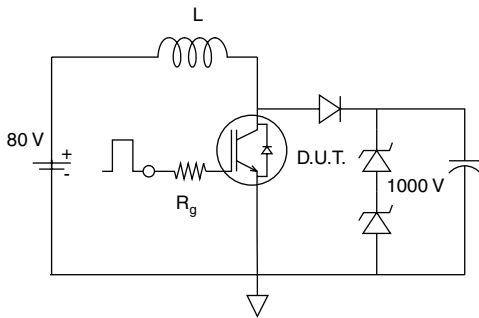


Fig. C.T.2 - RBSOA Circuit

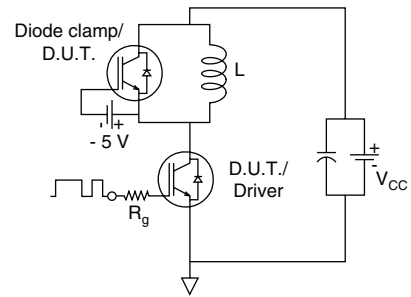


Fig. C.T.4 - Switching Loss Circuit

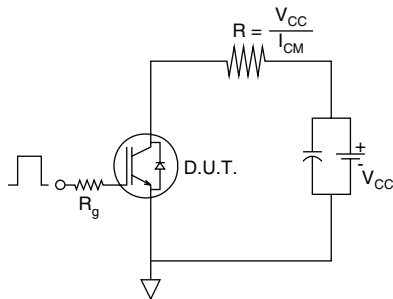


Fig. C.T.5 - Resistive Load Circuit

# GB75YF120UT

Vishay High Power Products IGBT Fourpack Module, 75 A

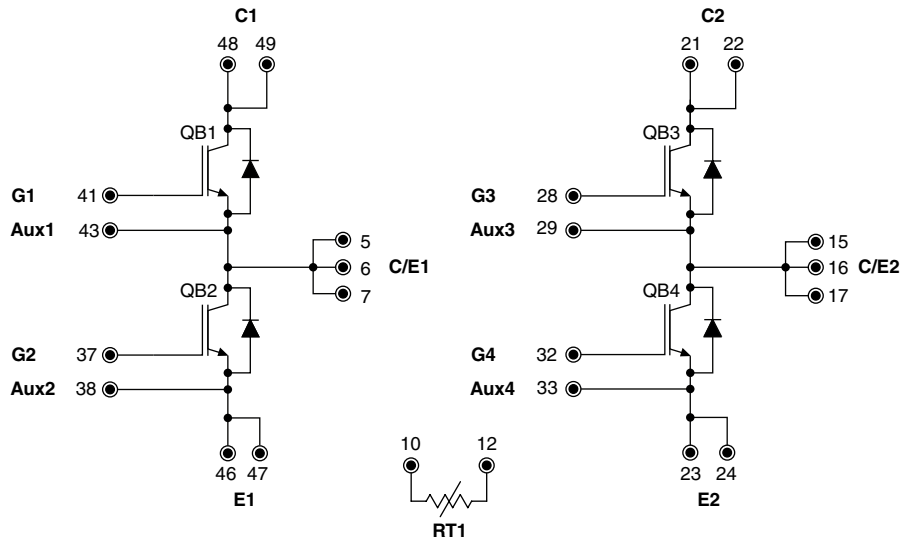


## ORDERING INFORMATION TABLE

|             |          |          |           |          |          |            |          |          |
|-------------|----------|----------|-----------|----------|----------|------------|----------|----------|
| Device code | <b>G</b> | <b>B</b> | <b>75</b> | <b>Y</b> | <b>F</b> | <b>120</b> | <b>U</b> | <b>T</b> |
|             | ①        | ②        | ③         | ④        | ⑤        | ⑥          | ⑦        | ⑧        |

- 1** - Insulated gate bipolar transistor (IGBT)
- 2** - B = IGBT Generation 5
- 3** - Current rating (75 = 75 A)
- 4** - Circuit configuration (Y = Fourpack)
- 5** - Package indicator (F = ECONO2)
- 6** - Voltage rating (120 = 1200 V)
- 7** - Speed/type (U = Ultrafast IGBT)
- 8** - T = Thermistor

## CIRCUIT CONFIGURATION



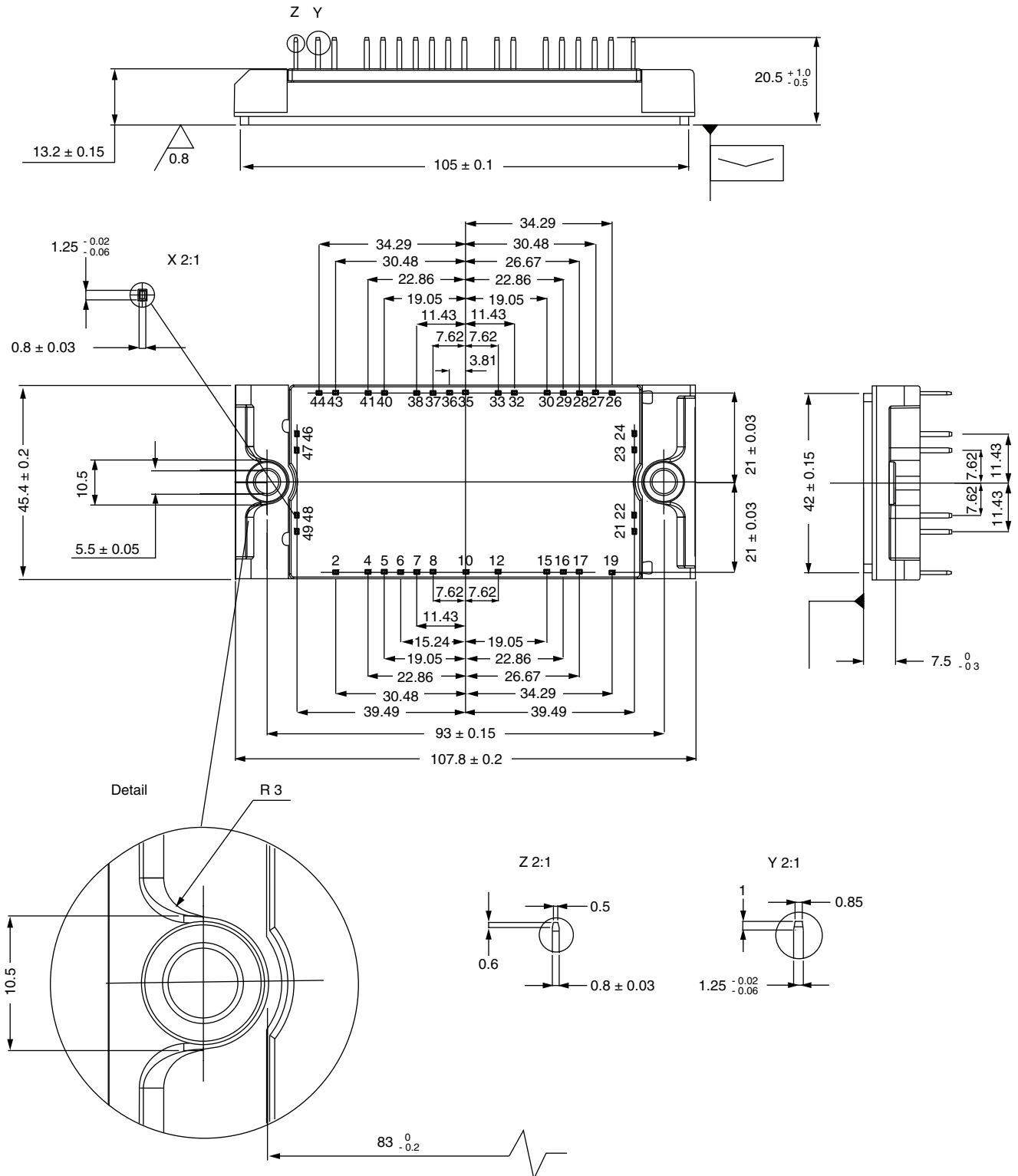
### LINKS TO RELATED DOCUMENTS

|            |  |
|------------|--|
| Dimensions | <a href="http://www.vishay.com/doc?95252">www.vishay.com/doc?95252</a> |
|------------|--|



## ECONO2 4PAK

**DIMENSIONS** in millimeters (inches)





## Disclaimer

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